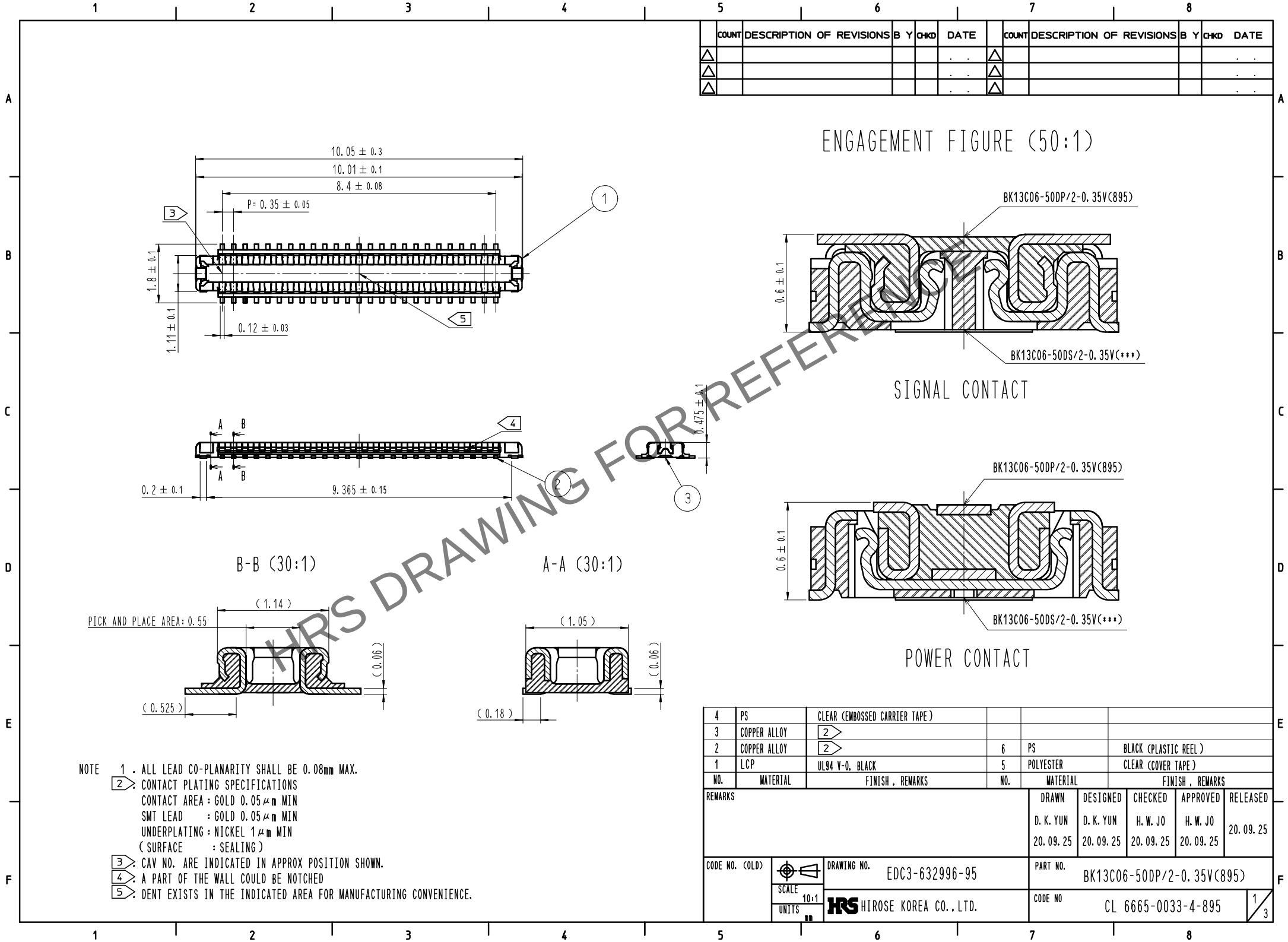
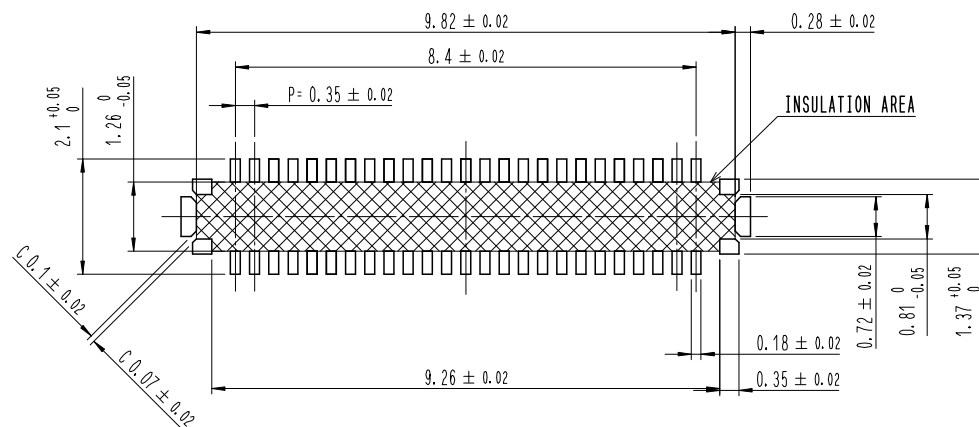


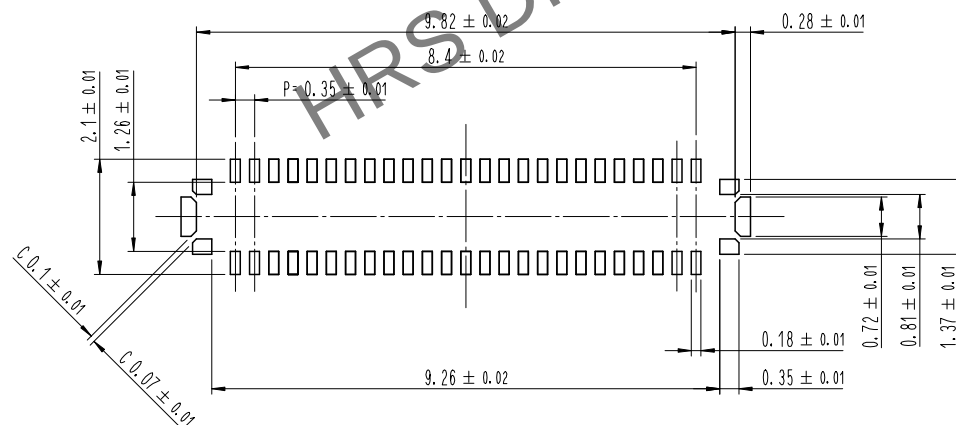


7 RECOMMENDED PCB LAYOUT

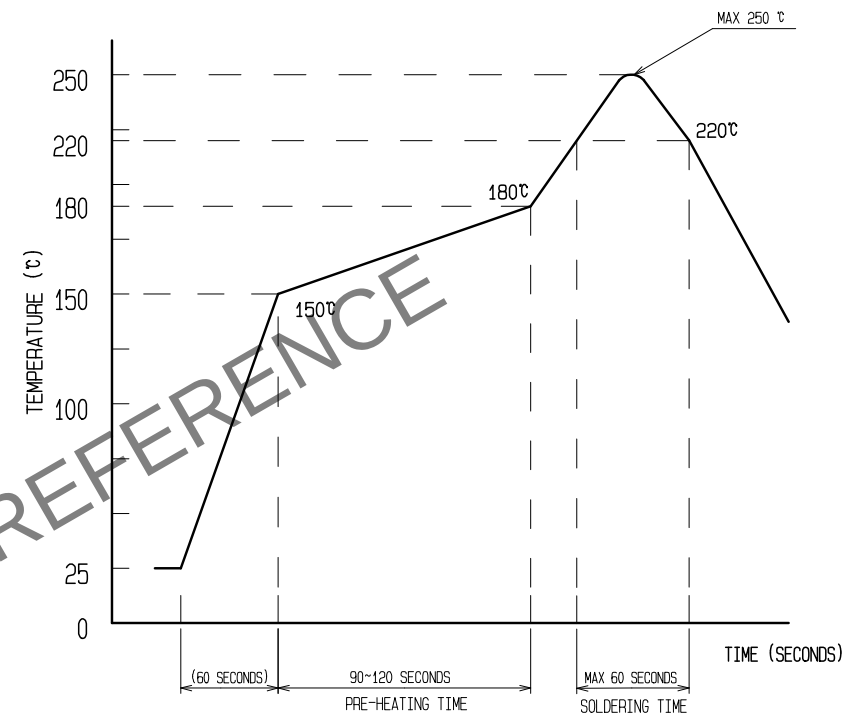


◆ RECOMMENDED METAL MASK DIMENSIONS

METAL MASK THICKNESS : 80 μm



6 ► RECOMMENDED REFLOW TEMPERATURE PROFILE
USING LEAD-FREE SOLDER PASTE.



REFLOW METHOD : N₂ REFLOW
NUMBER OF REFLOW CYCLES : 2 CYCLES MAX.
1) REFLOW TIME
DURATION ABOVE 220°C. 60 SEC MAX.
(PEAK TEMPERATURE : 250°C MAX)
2) PRE-HEAT TIME
PRE-HEAT TEMPERATURE(MIN): 150°C
PRE-HEAT TEMPERATURE(MAX): 180°C
PRE-HEAT TIME: 90-120 SEC.

6. THIS TEMPERATURE PROFILE IS PER THE CONDITIONS SHOWN ABOVE. ADDITIONAL FACTORS SUCH AS SOLDER PASTE TYPE, PCB SIZE AND OTHER MOUNTED COMPONENTS COULD AFFECT THE PROFILE. THEREFORE, A THOROUGH EVALUATION OF MOUNTING CONDITION IS REQUIRED PRIOR TO PRODUCTION. TEMPERATURE IS MEASURED AT CONTACT LEAD.

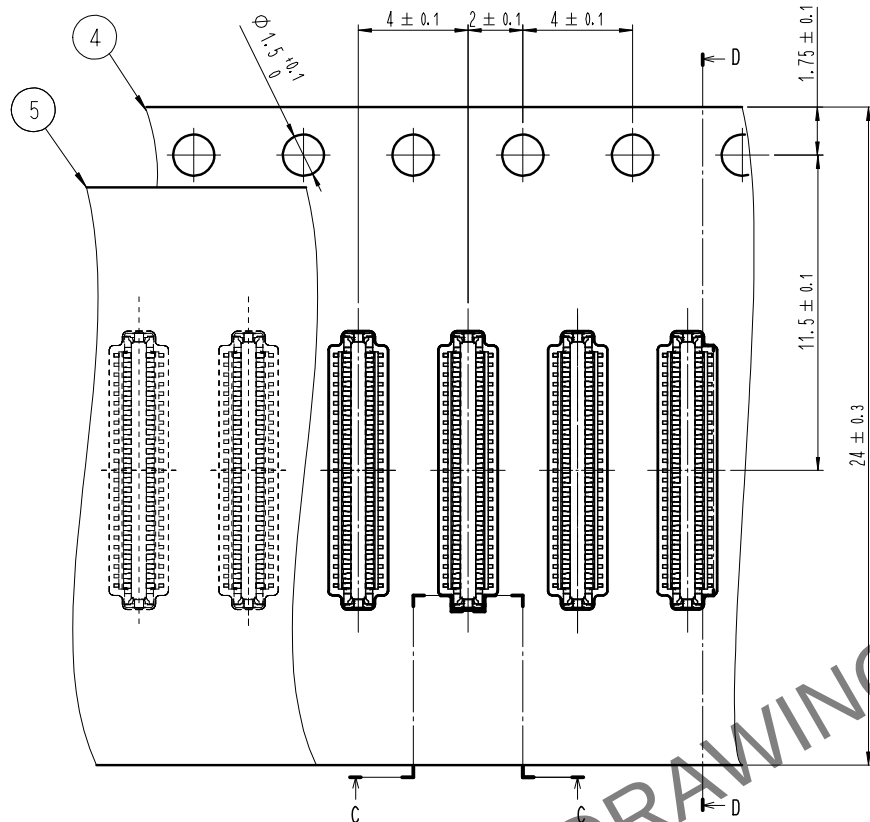
7. PLEASE CONTACT US IN CASE YOU WILL MAKE DIFFERENT SETTINGS FROM OUR RECOMMENDATION.

8. THIS PRODUCT SATISFIES HALOGEN FREE REQUIREMENTS DEFINED AS 900ppm MAXIMUM CHLORINE, 900ppm MAXIMUM BROMINE, AND 1500ppm MAXIMUM TOTAL OF CHLORINE AND BROMINE.

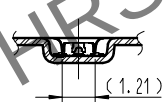
9. THIS PRODUCT COMPLY WITH ROHS.

	DRAWING NO.	EDC3-632996-95	PART NO.	BK13C06-50DP/2-0.35V(895)	
	SCALE 10:1 UNITS 	 HIROSE KOREA CO., LTD.		CODE NO	CL 6665-0033-4-895

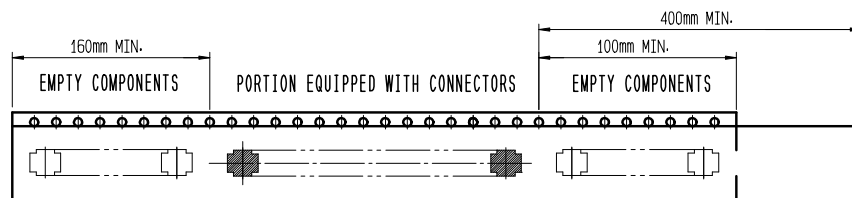
EMBOSSED CARRIER TAPE PACKAGING (5:1)



C-C (5:1)



DIRECTION OF UNREELING

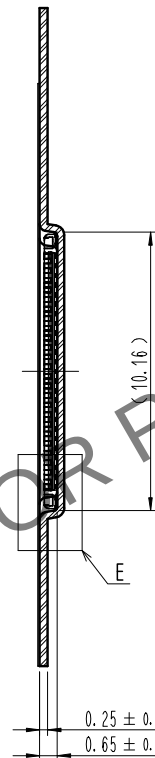


TRAILER

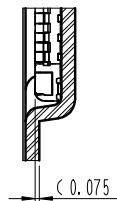
LEADER

TAPING(FREE)

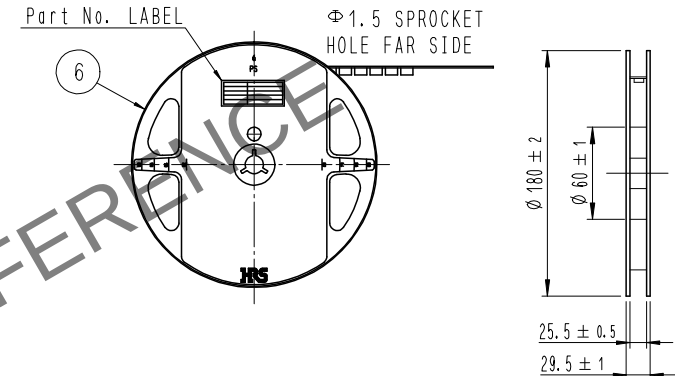
D-D (5:1)



E (10:1)



STYLE AND DIMENSION OF REEL (FREE)



DETAIL OF PART No. LABEL

SUPPLIER	QUANTITY	PART NO.	CODE NO.	DATE OF MANUFACTURED
生産月日	年	月	日	
図番	**	**	**	
品名	BK13C06-50DP/2-0.35V(895)			
納入数量	1,000個			
納入者	HIROSE KOREA			

10 . PER REEL 1,000 CONNECTORS.

11 . THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

12 REFER TO JIS C 0806, IEC-60286-3 (PACKAGING OF COMPONENTS FOR AUTOMATIC HANDLING)

DRAWING NO.	EDC3-632996-95	PART NO.	BK13C06-50DP/2-0.35V(895)
SCALE	10:1	CODE NO	CL 6665-0033-4-895
UNITS	HRS HIROSE KOREA CO., LTD.		